Post on handout deliberation 5-1

Handout deliberation 5-1
In the previous sections of this catalog we described equipment for production and dispersion of light into its component wavelengths. Here we describe detection systems. In a typical photo-research system a detector measures the radiant intensity used to evoke photo-response in a sample or the radiant intensity produced by the sample in response to light or other stimulation. The measurement is very frequently done after the beam has been separated into its component wavelengths. Light signals are converted into electrical signals, then typically amplified, processed by signal to noise improving electronics, and displayed. Computers are frequently utilized to present the measurements in a convenient form and in relation to other parameters such as the wavelength. The combined detection and measurement system is called a radiometer. The term spectroradiometer is used when radiant intensity versus wavelength information is displayed.

Detection systems are made possible by a few basic types of light-to-electrical signal conversion processes. Oriel detector systems can be roughly divided into:

- Thermal detectors
- Photon detectors

These are further divided by types of response generating processes. Wavelength and temporal response modifying phosphorescent accessories are used in some systems to adapt them to a particular UV measurement situation.

Oriel detector systems typically consist of actual detector elements packaged with the appropriate bias, cooling, and signal processing electronics as needed for proper operation. A short introduction to the terms used when describing the elements themselves will facilitate later discussion of system selection criteria. Please excuse certain lack of scientific rigor in defining exactly under what circumstances the following descriptions apply. However, space limitations force us to omit a number of details.

Most detectors are described by certain figures of merit. You'll see these terms on the detector specifications pages. The figures of merit are usually functions of wavelength and temperature and may also be affected by detector size, modulating frequency, bias voltage and the gain of any internal amplifier. We define them below.

**RESPONSIVITY (S)**

\[ S = \frac{Y}{X} \]

Where:

- \( Y \) = detector output
- \( X \) = radiation input

Examples of \( Y \) include current from a photomultiplier or voltage from a thermocouple. \( Y \) usually has a value \( Y_0 \) (dark signal) for \( X = 0 \). In this case

\[ S = \frac{Y - Y_0}{X} \]

\( X \) can be any radiative input. The units of \( X \) are usually watts or lumens. In cases of uniform irradiance on the detector, \( X \) may be given as the product of the irradiance and detector area.

\( S \) is usually wavelength dependent. The variation with wavelength is described by the Spectral Responsivity \( S(\lambda) \):

\[ S(\lambda) = \frac{dY(\lambda)}{dX(\lambda)} \]

Where:

- \( dY(\lambda) \) = the fraction of output due to input \( dX(\lambda) \) at \( \lambda \).

**QUANTUM EFFICIENCY (\( \eta \))**

This is the ratio of the number of basic signal elements produced by the detector to the number of incident photons. The basic signal element is frequently a photoelectron.

**RESPONSE TIME (\( t \))**

\( t \) is the time it takes a detector's output to rise when suddenly subjected to constant irradiance. When the irradiance is turned off, the detector output falls to 1/e of the initial value in one time constant. The rise and fall time constants are frequently different, since different physical parameters may cause them.

**LINEARITY RANGE**

This is the range of input radiant flux over which the signal output is a linear function of the input. The range is often stated in terms of input watts or input irradiance. It usually extends from the noise equivalent power level to an upper limit which may be device or external circuit limited.

![Fig. 1 Linearity of response of a silicon photodiode.](image)

**NOISE EQUIVALENT POWER (NEP)**

NEP is the radiant flux in watts necessary to give an output signal equal to the r.m.s. noise output from the detector. The flux may be either continuous or sinusoidally modulated. The response is assumed to be linear down to the noise level. NEP values should be stated at a specified wavelength, modulation frequency, detector area, temperature and detector bandwidth. Detector bandwidth is usually chosen as 1 Hz and NEP is frequently quoted in watts Hz\(^{-1/2}\).

NEP is the most commonly used version of Noise Equivalent Detector Input (\( P_{\text{N}} \)).

**DETECTIVITY (\( D \))**

\( D \) is the reciprocal of NEP. It is given by:

\[ D = \frac{1}{\sqrt{\text{NEP}}} \]

This gives a figure of merit which is larger for more sensitive detectors.
NORMALIZED DETECTIVITY (D*)

For most detectors, DA0^{1/2} is constant; i.e., the detectivity varies inversely with the square root of the area of the detector. This is because the electrical noise power is usually proportional to the detector area A0, and current or voltage, which provide a measure of that noise, are proportional to the square root of power. Similarly, because most detector noise is white noise, and the white noise power is proportional to Δf (where Δf is the electrical bandwidth), the noise signal is proportional to Δf^{1/2}.

D* is defined to allow comparison of different types of detectors independent of the detector area and bandwidth.

\[
D^* = D \left(A_0^{1/2} \Delta f^{1/2}\right)
= \left(A_0 \Delta f\right)^{1/2}
\frac{NEP}{\lambda}
\]

The units of D* are cm Hz^{1/2} W^{-1}. Since D*, like NEP, is a function of wavelength and modulation frequency, it is common to see the normalized spectral responsivity D*(λ), or D*(λ, Δf). Fig. 2 shows the D* of a number of our detectors.

SHOT NOISE is due to the discrete nature of radiation, which is composed of photons arriving randomly in time. Absorbed photons produce photoelectrons at random intervals, and this variation in current appears as noise. This noise can be generated by actual desired signal photons or, in case of very low signal and very low noise detectors, by background photon flux. When that occurs, the detector system is said to operate in a Background Limited In Performance (BLIP) mode.

Fig. 3 System noise.

Generation-recombination Noise is seen in photoconductors in which the absorbed photons produce both positive and negative charge carriers. Some of the free carriers may recombine before they are collected. Thermal excitation may generate additional carriers. Both the generation and recombination occur randomly, resulting in noise fluctuations in the output current.

Fig. 2 Approximate D* values as a function of wavelength for a number of detector types represented in this catalog.

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Johnson Noise or thermal noise is caused by the random motion of carriers in a conductor. The result is fluctuations in the detector’s internal resistance, or in any resistance in series with the detector’s terminals.

Flicker or 1/f Noise is not well understood. It occurs in detectors such as photoconductors which require a biasing current. Its magnitude is proportional to 1/fB where B is usually between 0.8 and 1.2.

Readout Noise is a characteristic of array detectors and is associated with the uncertainties introduced during the transfer of charges between storage registers.

In addition to the above noise sources, detector signals can be subject to microphonic noise, caused by vibration or shock and by post detector electronic noise. Often the circuitry after the detector determines the lowest measurable signal, particularly for detectors which do not provide some internal amplification of the photocurrent. By contrast, the almost noise-free internal amplification of photomultipliers accounts for their superb performance.

Finally, detectors are subject to temperature noise caused by fluctuations in their temperature. This can be a problem for small thermal detectors with low thermal mass.

CALIBRATION
There are a lot of measurement situations when the knowledge of the exact magnitude of an effect is not needed. A relative reading is all that is necessary. In that case we only have to make sure that the inputs are higher than the NEP level and lower than the damage level. Measurements become much simpler if the inputs are also within the linear range of the detection system response.

However, when absolute measurements are required to quantify the light flux, calibrated instruments are needed. We are equipped, by utilizing our broad range of light sources, detectors, electronics, optics, positioning equipment, and monochromators and spectographs, to provide single point or spectrally resolved calibration for most of the detector products we ship. For some detectors we offer optional PROMS that store a wavelength-responsivity table. We use calibration transfer standards, lamps and detectors, traceable to the National Institute of Standards and Technology (NIST) to ensure meaningful and reproducible calibrations.

THERMAL DETECTORS
Thermal detectors work by converting the incident radiation into a temperature rise. The temperature change can be measured in several ways. Our detectors use either the voltage generated at the junction of dissimilar metals, or the pyroelectric effect. In either case we have a “sensitive element” where we measure temperature change.

We blacken the sensitive element to enhance the absorption of the radiation. We choose the blackening material for its high and nearly uniform absorption, and hence detector responsivity, over a wide spectral range. This is a major advantage of thermal detectors.

The thickness of the black absorber is controlled to avoid adding excessive thermal mass to some detectors. High thermal mass slows the response time, increasing NEP.

We offer two types of Thermal Detectors:
1. Thermopile Detectors for DC radiation
2. Pyroelectric Detectors for pulsed or chopped radiation

THERMOCOUPLES
Radiation detecting thermocouples are based on thermocouples. A thermocouple consists of two dissimilar metals connected in series. To detect radiation, one junction is blackened to absorb the radiation. The temperature rise of the junction (with respect to another non-irradiated junction) generates a voltage. This effect, discovered by Seebeck, is the basis of all thermocouple temperature sensors.

The thermocouple materials are usually bismuth and antimony, which have a relatively high thermoelectric coefficient. Even with these materials, amplifier noise limits the detectivity because of the relatively low output voltage.

![Fig. 4 Principle of operation of a thermocouple detector. The dissimilar metals 1 and 2 are often bismuth and antimony. The sensing junction usually has a thin blackened metal foil attached to absorb more radiation. The other junction is shielded.](image-url)
Thermopiles

One way to increase the output voltage is to connect a number of the thermocouple junctions (typically 20 to 120) in series. All the "hot" junctions are placed close together to collect the radiation. This constitutes a thermopile. Thermopiles can be produced economically by thin film processes, yielding rugged units suitable for field use. These have time constants ranging from below 50 ms to over 200 ms, in small sizes with metal oxide blackening. Larger thermopiles, made with individual wire junctions backing up a highly absorbing black disk, have long time constants, more than a second in many cases.

Thermopiles exhibit no flicker, 1/f, noise, since no current bias is needed to operate them. Highly sensitive measurements can be made from DC to the few Hz frequency response limit of a particular device.

These devices are quite sensitive in the infrared, thanks to their broadband absorption. Therefore, care must be taken to stabilize their field of view, since all room temperature objects, including people, emit significant IR. Measurements are typically made by manually shuttering the radiation falling on the detector and observing the change in output voltage. It is not uncommon to see "negative" radiation if the source is cooler or less emissive than the shutter used to get "zero" reading.

Fig. 5 Schematic drawing of a thermopile detector.

Pyroelectric Detectors

A pyroelectric material has electric polarization even in the absence of an applied voltage. The materials are usually crystalline. On heating, the material expands and produces a change in the polarization which builds up a charge on opposite surfaces. This causes a current to flow in the circuit which connects the surfaces.

Since it is the change in temperature which produces the current, pyroelectric detectors respond only to pulsed or chopped radiation. They respond to variations in radiation much more rapidly than thermocouples or thermopiles and are unaffected by steady background radiation. Small detectors with small thermal mass can have extremely rapid response. Adding a black coating to give uniform absorption over a wide spectral range increases the mass and lowers the frequency response. This is significant as typical pyroelectric elements may be only 25 μm thick, while the coating is 75-100 μm thick.

The response of a pyroelectric detector depends on two time constants. The thermal time constant determined largely by the thermal mass and the thermal connections from the element to its surroundings, and the electrical time constant which is the product of the shunt resistance and shunt capacitance of the detector/amplifier circuit. Changing the load resistor changes the electrical time constant.

Fig. 6 Schematic of a pyroelectric detector.

Our pyroelectric detectors are designed for and used in two different modes:

1. As detectors of isolated or relatively infrequent (<4000 Hz) radiation pulses. The pulses may vary in width from picoseconds to milliseconds and in energy from nanojoules to joules.

2. As detectors of chopped radiation, where the incoming radiation is modulated and the detector produces an AC output signal.

The thermal and electrical time constants of pulse measuring detectors are chosen so each pulse is integrated and produces an output voltage peak. This peak is a measure of the charge produced by the detector and therefore of the pulse energy. The charge dissipates before the arrival of the next pulse. The relatively long integration time, or fall time, imposes limitations on the minimum interval between pulses or the repetition rate of pulses which can be individually measured.

The chopped mode detectors are much different. Here the measured radiation has a 50% duty cycle and the output signal is the average of a large number of chopping cycles. A lock-in detection system is used to remove most of the background radiation influence on readings; see page 3-14 for the theory of this device. The natural 100-200 Hz level response frequency limit of these pyroelectric detectors is electronically extended to the 1 kHz level to facilitate fast chopping. This is sometimes needed to remove background noise in thermally fast changing environments. However, the chopping frequency should be below 200 Hz for best inherent noise performance.
PHOTON DETECTORS

Photon or Quantum detectors respond to the incoming photon flux in a quantized manner. They produce, under perfect conditions, a single response element for a single photon. Of course, perfect conditions are not usually found in nature, therefore you must account for certain inefficiencies of response.

The single response elements can take on various forms. They can be a photoelectron in a detector with photomultiplying sensor, such as a photomultiplier tube; or an electron-hole pair separating in a junction photodiode, the basis of operation of silicon detectors; or an electron elevating from a valence to conduction band in photoconductors, as in a lead sulfide detector. The net result is either a change in current flow or voltage level which can then be processed by amplifiers and other electronics into a display or recording.

Before we discuss the different inefficiencies of conversion of photons to electrical signal, we should mention one significant difference between thermal and photon detectors. Thermal detectors respond to heat. This means that one watt delivered by 200 nm UV photons, produces the same response as one watt delivered by 10 µm infrared photons. Photon detectors produce at most one response element, prior to any amplification, per incoming photon. The energy carried by individual photons is inversely proportional to their wavelength. Therefore, for the same radiant power, the photon flux is much lower in the UV than in the IR. Accordingly, photon detector responsivity, in terms of V/W or A/W, is significantly lower in the ultraviolet part of the spectrum than in the infrared. When evaluating detector absolute performance it is important not only to look at the responsivity curves, vital as they may be to your actual application, but also at the quantum efficiency (QE) curves. The QE curve shows what percentage of the incoming photon flux is being converted into electrical signals, the efficiency of the detector. A relative responsivity curve for a 100% efficient photon detector, displayed on a customary semi-log graph, is shown in Fig. 7. The spectrally flat responsivity of a thermal detector is included for comparison.

Fig. 8 demonstrates a typical responsivity curve of a silicon detector and the corresponding quantum efficiency curve. We use it to discuss some of the inefficiencies in converting the incoming photon flux into an electrical signal. An ideal silicon detector has zero responsivity and quantum efficiency for photons with energies less than the band gap energy, or wavelength longer than approximately 1.1 µm. Just below the long wavelength limit the responsivity and QE should shoot up to approximately 0.9 A/W responsivity and 100% efficiency corresponding to each of the incident photons being converted into a single electron worth of current charge. For all the shorter wavelength photons we could expect 100% quantum efficiency and the responsivity to behave in a fashion similar to the curve in Fig. 7.

We see in Fig. 8 some of the features we were expecting, but the onset of responsivity is not as sudden as expected; we never get to 100% quantum efficiency, and we lose efficiency again at short wavelengths. Some of the reasons are discussed on the following pages.

Fig. 7 Relative spectral responsivities of perfect detectors.

Fig. 8 Silicon responsivity and quantum efficiency.
PHOTOEMISSIVE AND SEMICONDUCTOR JUNCTION DETECTORS

Common Characteristics

Photoemissive and semiconductor detectors have much in common.
1. The direct photo-electron interaction is very rapid so these detectors have the potential of following fast changing radiation levels.
2. Detectivity is in general higher than that of other detectors, but over a limited wavelength range.
3. All the detection mechanisms are wavelength dependent; i.e., there is a peak in responsivity with a fall off at both long and short wavelengths (Fig. 8). The long wavelength (low photon energy) cut-off occurs because there is a certain minimum photon energy required to cause photo emission, to produce charge carriers, or to generate hole-electron pairs.

The short wavelength cut-off is a function of two effects:
1. The responsivity in terms of power drops off because there are fewer short wavelength photons per watt, see Fig. 7.
2. At the extreme short wavelength end, the energetic photons may no longer be absorbed in the sensitive region. In the deep ultraviolet, absorption of the photons before they reach the sensitive region is also a problem. Detector windows, or surface coatings on semiconductors are strong absorbers of ultraviolet.

Between the upper and lower cut-offs, the quantum efficiency (events per photon) is approximately constant. It can be strongly affected by Fresnel reflection from the surface of the detector. For example, for the high index of refraction silicon diodes surface reflection accounts for most of the departure from 100% quantum efficiency in the middle wavelength region.

The long wavelength cut-off in response is softened by the associated fall off of the absorption coefficient. A lower absorption coefficient means that more photons pass through the thin photosensitive layers. These photons do not contribute to the quantum efficiency. This causes gradual roll off of quantum efficiency near the band gap limit, the long wavelength cut-off.

Photomultiplier Tubes, PMTs

In a photomultiplier detector, light interacts directly with the electrons in the detector material. An absorbed photon frees an electron and the surplus energy gets converted into kinetic energy of an electron. Electrons with enough kinetic energy escape from the surface. The electrons emitted in this way produce the cathode photocurrent in photomultiplier tubes. An applied voltage causes the electrons to flow toward the anode, creating a current that is proportional to light intensity over 6 to 8 orders of magnitude. The electron multiplier part of a photomultiplier tube amplifies the photocurrent by secondary emission. This is a low noise process which produces currents that are orders of magnitude larger than the initial photocurrent. Photomultipliers are more sensitive than any other detector in the near UV and visible regions. See pages 3-24 and 3-25 for photomultiplier tube specifications.

Fig. 9 shows a schematic depiction of an end-on tube. Our side-on tubes have similar components arranged in a much tighter geometry which makes packaging easier and removes some of the environmental sensitivities of these superb detectors. The end-on tubes have larger and more uniform photosensitive areas; side-on tubes have faster risetimes and reach higher responsivities since most of them use opaque photocathodes, thus avoiding the optical losses associated with the semitransparent photocathodes of the end-on tubes. Since nothing in life is simple, our fastest side-on tubes use a semitransparent photocathode because it allows even tighter packaging of the electron-multiplying dynode chain.

The stability of the electron multiplying process depends on the electronics following fairly exact trajectories. Magnetic fields can affect the directions of such electron flow in a significant manner, since the tubes are physically large. This is particularly noticeable in the end-on PMTs. You will find magnetic shielding, such as offered in most of our room temperature and cooled/stabilized housings, to greatly improve your measurement reproducibility.

These DC biased detectors, with 1 kV level bias voltages and voltage divider network currents of 100s of µA are characterized by flicker, 1/f noise. However, their excellent responsivity still allows them to function very well as DC detectors. Narrow bandwidth AC detection such as with our Merlin™ Digital Lock-in Amplifier, makes their already low NEP levels drop even further; 1W Hz^1/2 levels are typical.

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Junction Photodiodes

There are several ways of classifying semiconductor detectors. All are photoconductive, but here we use the photoconductive detectors' name for devices which rely on photoconductivity in the bulk and do not necessarily have junctions. We will talk more about them on page 3-12.

Junction detectors (or photodiodes) have a p-n junction formed in them. Photons absorbed near the p-n junction produce hole-electron pairs. Many junction detectors can be used in the photovoltaic mode without a bias, or in the photoconductive mode when a reverse bias is applied. They can also provide photocurrent amplification through an avalanche ionization process when back biased at near breakdown voltage in properly designed structures.

In the photovoltaic mode the electron-hole pairs migrate to opposite sides of the junction thus producing a voltage (and also a current, if the device is connected in a circuit).

In the photoconductive mode, a reverse bias is applied across the junction. Light produces electron-hole pairs which greatly increase the conductance. The current produced by the bias and free carriers is proportional to the light intensity over a wide range.

Silicon Photodiodes

Silicon photodiodes are the most common detectors of light used in instrumentation. The spectral response (Fig. 8 on page 3-8) covers the visible and near infrared. The linearity and dynamic range are excellent (Fig. 1 on page 3-4); getting a signal is simple.

- Fig. 10 shows the typical structure of a silicon photodiode. Photons pass through the thin top layer to generate electrons and holes near the junction. The junction is a region depleted of current carriers, both electrons and holes, by the gradients of the potentials associated with the energy bands. It is formed between the p and n type silicon. The junction drives holes into the p material and the electrons into the n material. This results in a voltage difference between the two regions, and if they are connected by external circuitry, a current.

Unbiased Operation - Photovoltaic Mode

Because the 1/f noise increases with bias, this mode has the better NEP at low frequencies, in fact the signal to noise ratio is better than that for biased operation at frequencies below 100 kHz and much better below 1 kHz.

Biased Operation - Photoconductive Mode

Operation with reverse bias reduces junction capacitance and thus increases the speed of response of the diodes. It is the preferred mode of operation for pulsed detectors.

Linear Range

Silicon diodes require a low impedance load resistor to provide a linear output in a photovoltaic mode. This makes the maximum output voltage too low to achieve wide dynamic range when using an oscilloscope as a monitor. A transimpedance amplifier solves the major linearity restrictions, by providing near "zero" load impedance, and allows higher output voltages. It also limits the high frequency response of the system. All our photovoltaic detectors are shipped with a transimpedance amplifier. Some are also equipped with handheld readout units, a general purpose one, or a radiometric quality one.

Linear performance is much easier to achieve in the back biased mode of operation even with 100 KΩ load. Linear output can be obtained almost all the way to bias voltage allowing easy display on an oscilloscope. We provide 6 V back bias from long life lithium batteries for our biased detectors.

Silicon Avalanche Photodiode, APD

As the electric field strength produced by bias voltage is increased, electrons gain more and more energy between collisions with the lattice. It is possible to provide them with enough energy so that electron multiplying avalanche process occurs. This is analogous to photomultiplier tubes, except that the process occurs inside a solid and not vacuum tube. This makes it a little more limited in capability, and also a little noisier. We offer a large area APD for high responsivity measurement needs, especially in the NIR.

InGaAs Photodiode

Just about everything we said about silicon detectors can also be said about the InGaAs diodes. They find most applications in the NIR, 0.8 to 1.7 μm. The yield of high grade large detectors is still limited, therefore we limit our offering to 3 mm diameter units. Both photovoltaic and back biased units are listed. We offer the photovoltaic units with two stage TE cooling for improved noise and stability performance. The smaller (0.3 mm diameter) pulse units provide nanosecond response times.

HgCdZnTe Photodiodes

Things get even more confusing as far as junction photoconductors vs. bulk photoconductors with these small band gap IR photodetectors. However, at least two room temperature implementations of these new detectors do function in a photovoltaic mode and thus deserve to be listed in this section. Their current biased versions fit better with the PbS and PbSe photoconductors than with back biased junction diodes. Therefore, we talk about them a little more in that section, page 3-12.

We offer these detectors for the 2 to 12 μm wavelength range. Optical immersion, see page 3-12, is offered with most of them to take better advantage of the detector active area.
MULTICHANNEL DETECTORS

The detectors we've been describing until now are single, discrete devices. Now we talk about multichannel detectors - photodiode arrays and charge coupled devices. The major differences between them lie in the sizes of the sensitive elements or pixels, the linear versus two dimensional value of the arrays, and the signal handling and readout methods. Our InstaSpec™ family of multichannel detectors (pages 3-81 to 3-103) utilizes silicon as a detector and is therefore sensitive in the 200 nm to 1100 nm spectral range.

The most useful arrays, and the only kind in our catalog, are of a self scanning type. This means that individual detector elements, and their associated circuitry, integrate the incident photon flux for some time and then are read out in a serial fashion. This is significantly different from the real time operation of single element detector systems. This self scanning mode of operation limits the nine or ten orders of magnitude dynamic range of individual photodiodes to a more practical four or five orders of magnitude, device dependent. High density packing of the small photosensitive pixels, to minimize non-photoresponsive areas and provide high resolution, limits the capacity of the charge storing structures. The major benefit of this charge storage capability is that usually only a single data channel is needed to read the information from all the spectral or imaging channels.

All of the arrays share the major advantage of multichannel or multiplexing capability. They make possible an almost instantaneous acquisition of one or more full spectroradiometric data sets when coupled to a standard or imaging spectograph. The traditional technique would have involved mechanical scanning of one or more monochromators to sequentially bring various wavelengths of light to the single detector location.

Photodiode Arrays (PDA)

Our PDAs are of a linear format. The aspect ratio of individual pixels, 25 µm wide by 25 mm high, is designed to complement spectograph function. Narrow width gives high resolution; significant height allows more signal collection. They operate in a photoconductive mode. The individual diode elements respond to the photon flux by producing photocurrents. Those in turn charge individual storage capacitors. The capacitors are read and discharged in turn by on-chip circuitry and the information is fed out in a timed sequence.

Integration time becomes a new and significant parameter when setting up your measurement with the arrays. Dark current plays a more significant role with these storing detectors, since with very long integration times you may reach full capacity of all the storage elements and thus wipe out all the useful information. A concept of saturation time is used to describe this phenomenon. Fig. 11 shows a typical temperature dependence of saturation time for PDAs.

We offer a number of PDA based systems. Compared to CCDs, their advantage is lower cost and higher light exposure capability. Their disadvantage involves higher readout noise, hundreds to thousands of electrons per channel, which limits their ultimate detectivity.

Charge Coupled Devices (CCD)

These two dimensional arrays offer different electronic construction than PDAs. They are characterized by extremely low readout noise, a few electrons worth per pixel, and good separation between signal channels - no blooming. Nothing in life being free, they are somewhat more expensive than PDAs.

Typical pixel elements are 27 µm square. Software options allow you to take advantage of the two dimensional nature of CCDs for a spectroscopic form of imaging. (You could use them for standard high light level imaging, but a video recorder tube can do that for significantly lower cost). Fig. 12 shows this spectroscopic "imaging". Multiple, spatially separated inputs illuminate the entrance slit of an imaging spectograph. The spectrally resolved image of the sources illuminates the CCD at the output plane of the spectograph. Multiple spectra, e.g. of excitation and various responses, can then be displayed simultaneously for comparison and analysis.

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Fig. 11 PDA saturation time vs. temperature.

Fig. 12 Simultaneous multisource spectra taken with InstaSpec™ IV CCD and MultiSpec™ 257 Imaging Spectrograph.
PHOTOCONDUCTIVE DETECTORS

In photoconductive detectors, absorbed incident photons produce free charge carriers. These change the electrical conductivity of the detector. An applied voltage, or bias, causes a current to flow which is proportional to the photon irradiance (it helps if the dark resistance is very high). Lead sulfide and lead selenide are examples of this type of detector. Fig. 13 shows the concept.

Fig. 13 Schematic of a photoconductive detector.

PbS and PbSe detectors are fabricated by chemically depositing polycrystalline film on a quartz substrate. Gold electrodes are plated to the edges of the film to provide electrical contact and the whole assembly is sealed inside a package with an appropriate window, quartz or sapphire. See Fig. 14. The cooled lead salt detectors also include the TE cooling stages and a thermistor sensor inside of the housing. This minimizes the cooling requirements, since the housing minimizes heat transfer from the environment to the detector element. The heat being generated by the TE coolers also protects the window from condensation.

Fig. 14 Typical lead salt detector.

The epitaxially grown HgCdZnTe family of detectors is characterized by low impedance, but when properly biased and interfaced also provides linear performance. This versatile room and near room temperature operation family of detectors does not exactly fit either the junction or bulk photoconductor description. However, it is similar to one or the other in its different modes of operation. In the photoconductive mode of operation it is characterized by significantly faster rise times than the lead salt detectors, especially at longer wavelengths.

Bias requirements, and the associated heating, as well as noise generation is smaller in smaller detectors. One way to make a small detector look optically like a big detector is through the use of optical immersion, Fig. 15.

This approach makes the detector surface look n^2 times larger, where n is the index of refraction of the lens, for the hyperspherical lens shape used in our optically immersed detectors. The monolithic construction of these detectors, the epitaxial layer is grown directly on the lens substrate, makes this approach highly effective for our HgCdZnTe detectors.

Fig. 15 Principle of optical immersion.

Fig. 16 Typical detectivities of some of our cooled IR detectors.

Dimensions in inches.
The constantly improving technology of detectors and wide selection of materials and detection methods allows most light detection needs to be satisfied by fairly simple systems. At the same time, with so many choices, selecting the best system can be confusing.

This and the following pages were written to simplify the selection process and help you make an educated choice. General selection guidelines are listed on pages 3-15 to 3-18; these two pages discuss getting more out of your detector when experimental conditions start mixing noise and signal in too close a ratio.

LOOK ONLY FOR WHAT YOU WANT TO SEE

This is the main theme of this section. We talk about minimizing the influence of noise understood in the broadest sense of the word, i.e., any contribution which lessens our ability to get a meaningful measurement.

The suggestions below may sound trivial, but we offer them anyway, since we continue to amaze ourselves with how often we forget to go through this simple analysis when setting up a new experiment.

Fig. 1 graphically depicts what we'll be talking about - the four criteria for choosing the best match of detector response to signal characteristics. These sketches will look the same if the abscissae are labeled:

- Wavelength
- Bandwidth
- Time
- Field of View

This figure shows a variety of poor matches, a good match and the best match.

Wavelength

The detector sensitivity must cover the wavelength range of your signal. If the detector's sensitivity wavelength range exceeds that of the signal, any radiation outside of the signal range will contribute to noise. Use a bandpass filter to narrow the range of wavelengths seen by the detector. If the detector and signal ranges miss each other partially, then some of the signal information is lost - also a form of noise. The "Good" and "Best" cases in Fig. 1 demonstrate full capture of signal information with wavelength mismatch contributing little or nothing to system noise.

Bandwidth

Frequency bandwidth is the most often adjusted factor in trying to reduce noise contribution. This is because it very explicitly enters the noise equations in the form of

\[
(BANDWIDTH)^{1/2}
\]

and we are reminded of it with the frequent appearance of the Hz \( \times \) expression in the units fields of white, frequency independent, noise contributions. This applies to Johnson and shot noises. Moving up in frequency to minimize the 1/f noise is another form of bandwidth control. AC detection methods, to be discussed in more detail on the next page, take advantage of various forms of electronic and digital filters to match the detection bandwidth to the frequency spectrum representing the rate of change of the useful signal. AC methods are particularly beneficial in the infrared part of the spectrum due to the large amount of background radiation.

Time

Particular events may occur at specific time intervals and for specific lengths of time. There are a number of techniques to first create this periodic behavior, if it is not naturally occurring, and then using it to improve the signal-to-noise ratio. It is important that the characteristic signal frequency be as different as possible from the natural modulation frequencies of the noise sources (60 Hz (50 Hz) line frequency and its harmonics are notorious). Choppers are frequently used for source modulation. Some "good" modulation frequencies include 30 Hz (25 Hz), 90 Hz (75 Hz), etc. Higher modulation frequencies are required for measuring fast changing signals. Narrow bandwidth AC detection methods, of which the lock-in technique is the most widely used, are used to take advantage of the signal modulation. They can be used with continuous signal sources. Gated averagers or integrators are used to improve the signal to noise ratio in the measurement of pulsed sources.

Field of View

This is a very important criterion for infrared detectors. Because room temperature objects emit infrared photons, particularly in the vicinity of 10 μm, you need to narrow the field of view to receive radiation mostly from the source of interest. Imaging and aperturing should be put to use as this effort will pay big dividends in providing you with meaningful and reproducible results.
GENERAL NOISE REDUCTION TECHNIQUES

Temperature Control

Most detectors have some temperature dependence in their noise and responsivity characteristics. You will obtain more reproducible results if you stabilize the thermal environment of your experiment. You will typically improve your detectivity limits by cooling your detector to operate below room temperature. The degree of gain in performance depends on detector type and post detection electronics. However, you will do significantly better with cooled detectors which respond to the infrared part of the spectrum. Dark currents diminish a factor of 2 every 5 to 20 °C, depending on the system's characteristic energy, e.g. band gap or work function.

Ratios

No source is perfectly stable. Whenever possible, ratio your response signal to that of the source to obtain the most accurate results.

AC Techniques

It may sound funny to use AC techniques to measure DC signals but it actually is the best way in practice. You can encode your signal with a known modulation and then use this characteristic modulation to discriminate against noise contribution which will have its power spread over a different and wider band of frequencies.

An AC coupled amplifier with a narrow band filter centered on the modulation frequency will help you significantly increase your signal to noise ratio. You can narrow the filter frequency pass band only to the limit of your modulator stability. If the noise contribution is still too much you will have to revert to lock-in techniques. These depend on the amplifier actively tracking the modulator frequency and thus allowing much narrower band filtering to be used. We do a lot of this filtering in the digital part of Merlin, eliminating phase and amplitude drifts associated with the older analog lock-ins.

Gated Integration/Box Car Averaging

These techniques take their name from the appearance of the pictorial representation of the process, Fig. 2. Gates, boxes, or "windows" are used to define the times during which the electronics acquire signal. During those gated times, the signal to noise ratio is already improved, since noise contributions which would be accumulated during the off times are absent. The process, when repeated for N pulses, will lead to signal to noise ratio improvement of N⁻¹/₂ if the noise is of the white variety, Johnson or shot. This is because the integrated signal contribution increases as N, while noise contribution increases only as N⁻¹/₂.

Fig. 2 Repetitive signal and detection "windows".

BEWARE

• AC coupled detectors may be subject to DC saturation (from background) and thus loss of linearity. You must understand your detector's DC response limits when using it in an AC coupled mode of operation.

• Watch out for frequency roll-offs. The post detection electronics frequently limits the frequency response of your detector. There may be multiple bandwidths associated with a particular piece of equipment, which depend on the selected gains.

RULES OF THUMB AND MAGIC

YOU CANNOT BEAT JOHNSON NOISE, but you can minimize its contribution to the S/N ratio.

1. PMTs: You should try to make the bias current shot noise the dominant AC noise contributor in a PMT based detection system. Make this noise three or more times bigger than Johnson noise and you have effectively negated the influence of Johnson noise on the system's S/N behavior. In low light situations start by choosing your transimpedance gain to be the maximum allowed by bandwidth requirements. Note the AC noise at the PMT output with zero volts of bias (Johnson Noise). Now, raise your bias voltage, within the safe range of the tube, until the dark current AC shot noise is about three times greater than Johnson noise, i.e. you want to see variance about four times the level of zero bias case. You are now ready to measure your signals with a high degree of linearity, since the shot noise and photon signal and noise are amplified the same amount in the electron multiplier chain. If you only intend to measure very low signals then you should consider photon counting. Call us for new systems!

2. PbS, PbSe: You will never reach the photon noise limit with these detectors, but you should still operate at a bias current level producing shot noise equal to about three times the Johnson noise.

Note: be careful not to exceed the maximum bias voltage of the devices - catastrophic destruction of the detector will occur if you do.

3. Photodiodes: If the DC voltage generated through a transimpedance amplifier is greater than about 500 mV, photon noise is more than three times greater than Johnson noise.